

LM2724A

High Speed 3A Synchronous MOSFET Driver

General Description

The LM2724A is a dual N-channel MOSFET driver which can drive both the top and bottom MOSFETs in a push-pull structure simultaneously. The LM2724A takes a logic input and splits it into two complimentary signals with a typical 20ns dead time in between. The built-in cross-conduction protection circuitry prevents the top and bottom MOSFETs from turning on simultaneously. With a bias voltage of 5V, the peak sourcing and sinking current for each driver of the LM2724A is about 3A. Input UVLO (Under-Voltage-Lock-Out) ensures that all the driver outputs stay low until the supply rail exceeds the power-on threshold during system power on, or after the supply rail drops below power-on threshold by a specified hysteresis during system power down. The cross-conduction protection circuitry detects both driver outputs and will not turn on a driver until the other driver output is low. The top gate voltage needed by the top MOSFET is obtained through an external boot-strap structure. When not switching, the LM2724A only draws up to

195 μ A from the 5V rail. The synchronization operation of the bottom MOSFET can be disabled by pulling the SYNC pin to ground.

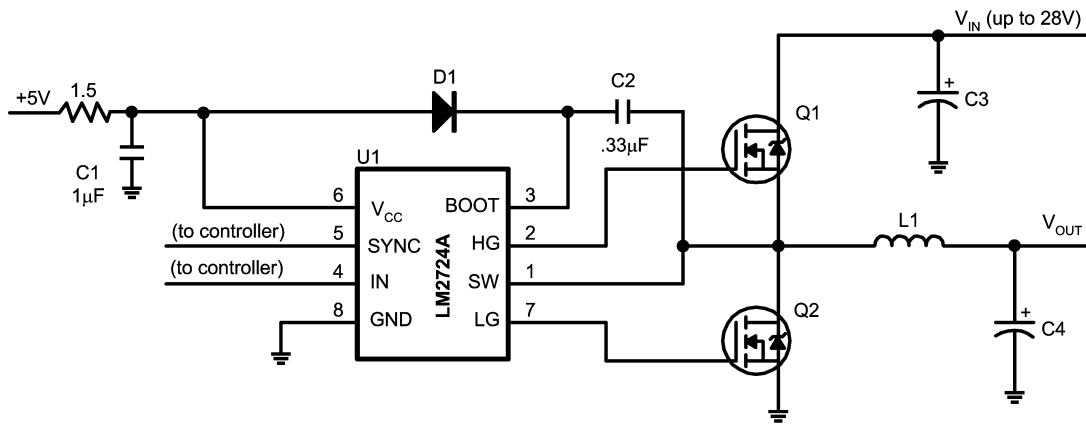
Features

- Shoot-through protection
- Input Under-Voltage-Lock-Out
- 3A peak driving current
- 195 μ A quiescent current
- 28V input voltage in buck configuration
- SO-8 and LLP packages

Applications

- High Current DC/DC Power Supplies
- High Input Voltage Switching Regulators
- Fast Transient Microprocessors
- Notebook Computers

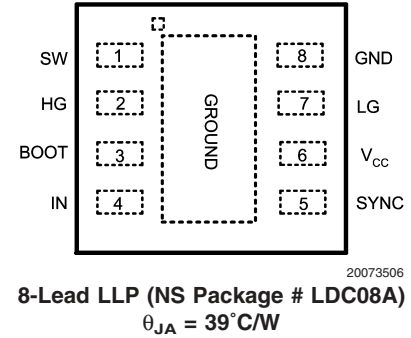
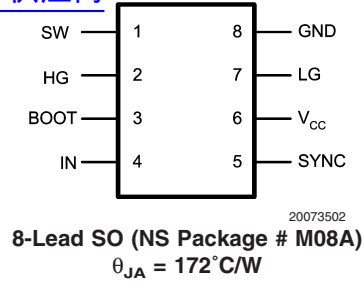
Typical Application



20073501

Connection Diagram

请向"LM2724A"供应商



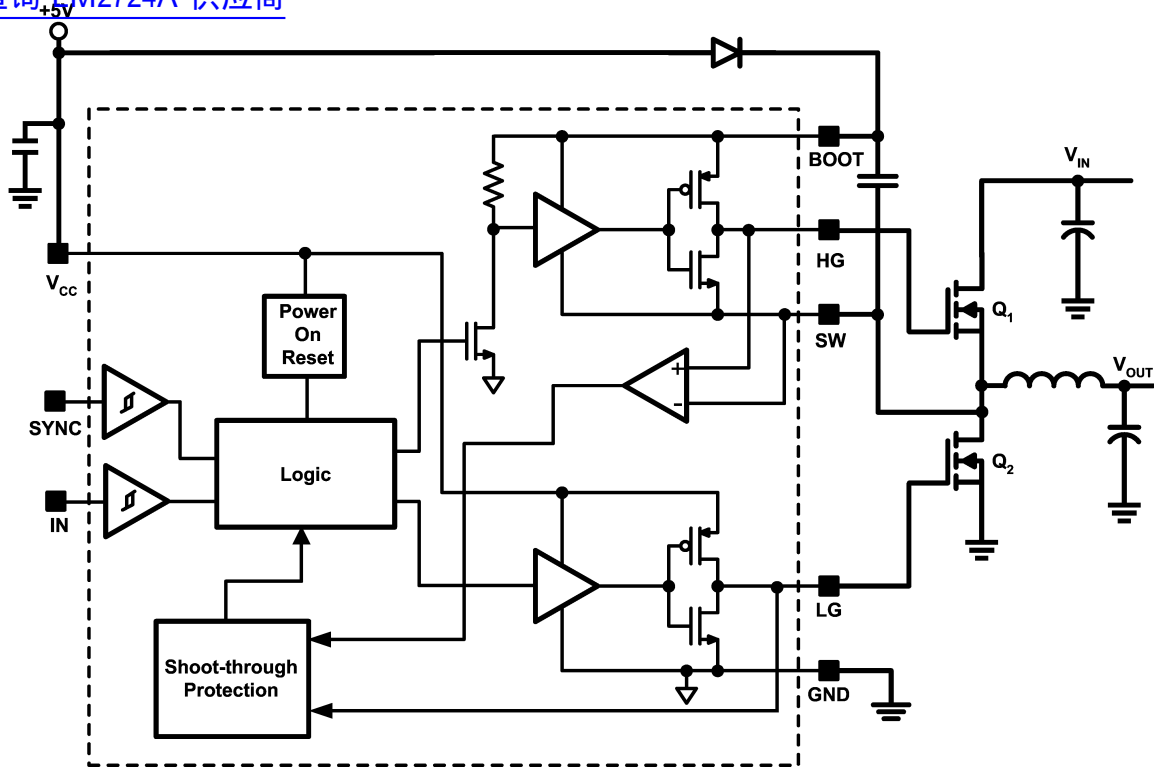
Ordering Information

| Order Number | Size | NSC Package Drawing | Supplied As |
|--------------|--------|---------------------|-----------------|
| LM2724AM | SO-8 | M08A | 95 Units/Rail |
| LM2724AMX | | | 2500 Units/Reel |
| LM2724ALD | LDC08A | LDC08A | 1000 Units/Rail |
| LM2724ALDX | | | 4500 Units/Reel |

Pin Descriptions

| Pin | Name | Function |
|-----|-----------------|--|
| 1 | SW | Top driver return. Should be connected to the common node of top and bottom FETs |
| 2 | HG | Top gate drive output. Should be connected to the top FET gate. |
| 3 | BOOT | Bootstrap. Accepts a bootstrap voltage for powering the high-side driver |
| 4 | IN | Accepts a logic control signal |
| 5 | SYNC | Bottom gate enable |
| 6 | V _{CC} | Connect to +5V supply |
| 7 | LG | Bottom gate drive output. Should be connected to the bottom FET gate. |
| 8 | GND | Ground |

Block Diagram

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Absolute Maximum Ratings (Note 1)

In Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

| | |
|----------------------|--------------|
| V_{CC} | 7V |
| BOOT to SW | 7V |
| BOOT to GND (Note 2) | 35V |
| SW to GND | 30V |
| Junction Temperature | +150°C |
| Power Dissipation | 720mW (SO-8) |
| (Note 3) | 3.2W (LLP-8) |

| | |
|-----------------------------|----------------|
| Storage Temperature | -65°C to 150°C |
| ESD Susceptibility | |
| Human Body Model (Note 4) | 2.0 kV |
| Soldering Time, Temperature | 10sec., 300°C |

Operating Ratings (Note 1)

| | |
|----------------------------|----------------|
| V_{CC} | 4.3V to 6.8V |
| Junction Temperature Range | -40°C to 125°C |

Electrical Characteristics
LM2724A

$V_{CC} = \text{BOOT} = \text{SYNC} = 5\text{V}$, $\text{SW} = \text{GND} = 0\text{V}$, unless otherwise specified. Typical and limits appearing in plain type apply for $T_A = T_J = +25^\circ\text{C}$. Limits appearing in **boldface** type apply over the entire operating temperature range.

| Symbol | Parameter | Condition | Min | Typ | Max | Units |
|----------------------|---|---|------------|------|------------|---------------|
| POWER SUPPLY | | | | | | |
| I_{Q_op} | Operating Quiescent Current | IN = 0V | | 145 | 195 | μA |
| TOP DRIVER | | | | | | |
| | Peak Pull-Up Current | | | 3.0 | | A |
| | Pull-Up R_{ds_on} | $I_{BOOT} = I_{HG} = 0.3\text{A}$ | | 1.2 | | Ω |
| | Peak Pull-down Current | | | -3.2 | | A |
| | Pull-down R_{ds_on} | $I_{SW} = I_{HG} = 0.3\text{A}$ | | 0.5 | | Ω |
| t_4 | Rise Time | Timing Diagram, $C_{LOAD} = 3.3\text{nF}$ | | 17 | | ns |
| t_6 | Fall Time | | | 12 | | ns |
| t_3 | Pull-Up Dead Time | Timing Diagram | | 19 | | ns |
| t_5 | Pull-Down Delay | Timing Diagram, from IN Falling Edge | | 27 | | ns |
| BOTTOM DRIVER | | | | | | |
| | Peak Pull-Up Current | | | 3.2 | | A |
| | Pull-up R_{ds_on} | $I_{VCC} = I_{LG} = 0.3\text{A}$ | | 1.1 | | Ω |
| | Peak Pull-down Current | | | 3.2 | | A |
| | Pull-down R_{ds_on} | $I_{GND} = I_{LG} = 0.3\text{A}$ | | 0.6 | | Ω |
| t_8 | Rise Time | Timing Diagram, $C_{LOAD} = 3.3\text{nF}$ | | 17 | | ns |
| t_2 | Fall Time | | | 14 | | ns |
| t_7 | Pull-up Dead Time | Timing Diagram | | 22 | | ns |
| t_1 | Pull-down Delay | Timing Diagram | | 13 | | ns |
| LOGIC | | | | | | |
| V_{uvlo_up} | V_{CC} Under-Voltage-Lock-Out Upper Threshold | V_{CC} rises from 0V toward 5V | | | 4 | V |
| V_{uvlo_dn} | V_{CC} Under-Voltage-Lock-Out Lower Threshold | V_{CC} falls from 5V toward 0V | 2.5 | | | V |
| V_{uvlo_hys} | V_{CC} Under-Voltage-Lock-Out Hysteresis | V_{CC} falls from 5V toward 0V | | 0.8 | | V |
| V_{IH_SYNC} | SYNC Pin High Input | | 55% | | | V_{CC} |
| V_{IL_SYNC} | SYNC Pin Low Input | | | | 25% | |
| I_{leak_SYNC} | SYNC Pin Leakage Current | SYNC = 5V, Sink Current | | | 2 | μA |
| | | SYNC = 0V, Source Current | | | 10 | |

Electrical Characteristics

LM2724A (Continued)

$V_{CC} = \text{BOOT} = \text{SYNC} = 5\text{V}$, $\text{SW} = \text{GND} = 0\text{V}$, unless otherwise specified. Typical and limits appearing in plain type apply for $T_A = T_J = +25^\circ\text{C}$. Limits appearing in **boldface** type apply over the entire operating temperature range.

| Symbol | Parameter | Condition | Min | Typ | Max | Units |
|------------------------|---|-------------------------------|------------|-----|------------|---------------|
| $I_{\text{leak_IN}}$ | IN Pin Leakage Current | IN = 0V, Source Current | | | 2 | μA |
| | | IN = 5V, Sink Current | | | 10 | |
| $t_{\text{on_min1}}$ | Minimum Positive Pulse Width at IN Pin (Note 5) | | | 160 | | ns |
| $t_{\text{on_min2}}$ | Minimum Positive Pulse Width at IN Pin for HG to Respond (Note 6) | | | 45 | | |
| $t_{\text{on_min3}}$ | Minimum Positive Pulse Width at IN Pin for LG to Respond (Note 7) | | | 10 | | |
| $t_{\text{off_min1}}$ | Minimum Negative Pulse Width at IN Pin for LG to Respond (Note 8) | | | 40 | | |
| $t_{\text{off_min2}}$ | Minimum Negative Pulse Width at IN Pin for HG to Respond (Note 9) | | | 5 | | |
| $V_{\text{IH_IN}}$ | IN High Level Input Voltage | When IN pin goes high from 0V | 55% | | | V_{CC} |
| $V_{\text{IL_IN}}$ | IN Low Level Input Voltage | When IN pin goes low from 5V | | | 25% | |

Note 1: Absolute Maximum Ratings are limits beyond which damage to the device may occur. **Operating ratings** are conditions under which the device operates correctly. The guaranteed specifications apply only for the listed test conditions. Some performance characteristics may degrade when the part is not operated under listed conditions.

Note 2: If BOOT voltage exceeds this value, the ESD structure will degrade.

Note 3: Maximum allowable power dissipation is a function of the maximum junction temperature, $T_{J\text{MAX}}$, the junction-to-ambient thermal resistance, θ_{JA} , and the ambient temperature, T_A . The maximum allowable power dissipation at any ambient temperature is calculated using: $P_{\text{MAX}} = (T_{J\text{MAX}} - T_A) / \theta_{JA}$. The junction-to-ambient thermal resistance, θ_{JA} , for LM2724A is 172°C/W . For a $T_{J\text{MAX}}$ of 150°C and T_A of 25°C , the maximum allowable power dissipation is 0.7W. The θ_{JA} , for LM2724A LLP package is 39°C/W . For a $T_{J\text{MAX}}$ of 150°C and T_A of 25°C , the maximum allowable power dissipation is 3.2W.

Note 4: ESD machine model susceptibility is 200V.

Note 5: If the positive pulse width at IN pin is below this value but above $t_{\text{on_min2}}$, the pulse is internally stretched to $t_{\text{on_min1}}$, so the HG width will be a constant value.

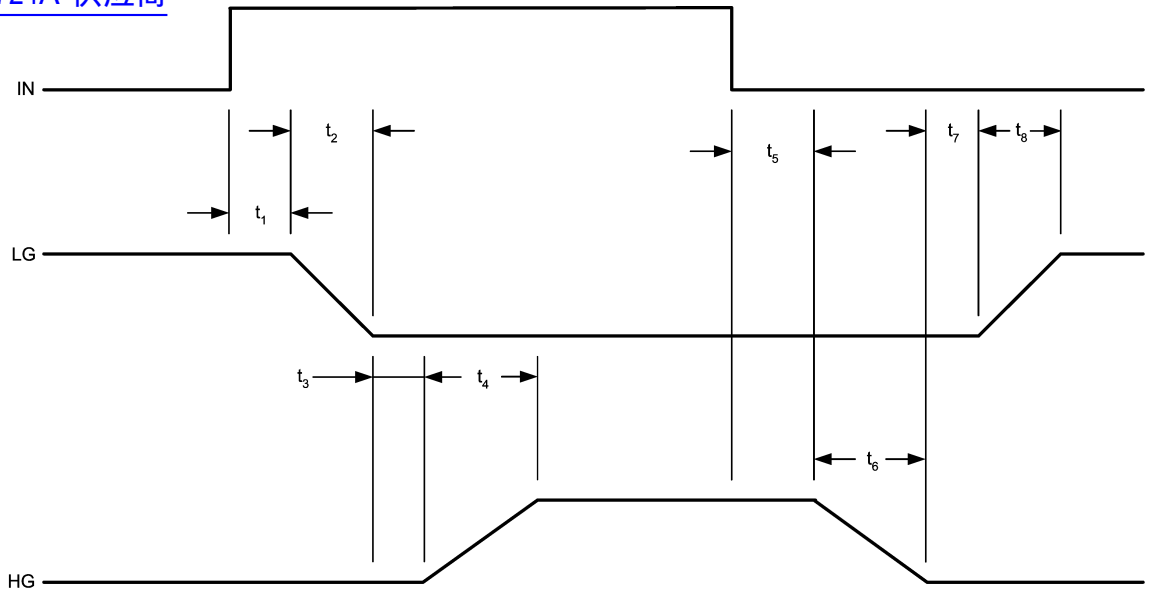
Note 6: If the positive pulse width at IN pin is below this value but above $t_{\text{on_min3}}$, then HG stops responding while LG still responds to the pulse.

Note 7: If the positive pulse width at IN pin is below this value, the pulse will be completely ignored. Neither HG or LG will respond to it.

Note 8: If the negative pulse width at IN pin is below this value but above $t_{\text{off_min2}}$, then LG stops responding while HG still responds.

Note 9: If the negative pulse width at IN pin is below this value, the pulse will be completely ignored. Neither HG or LG will respond to it.

Timing Diagram

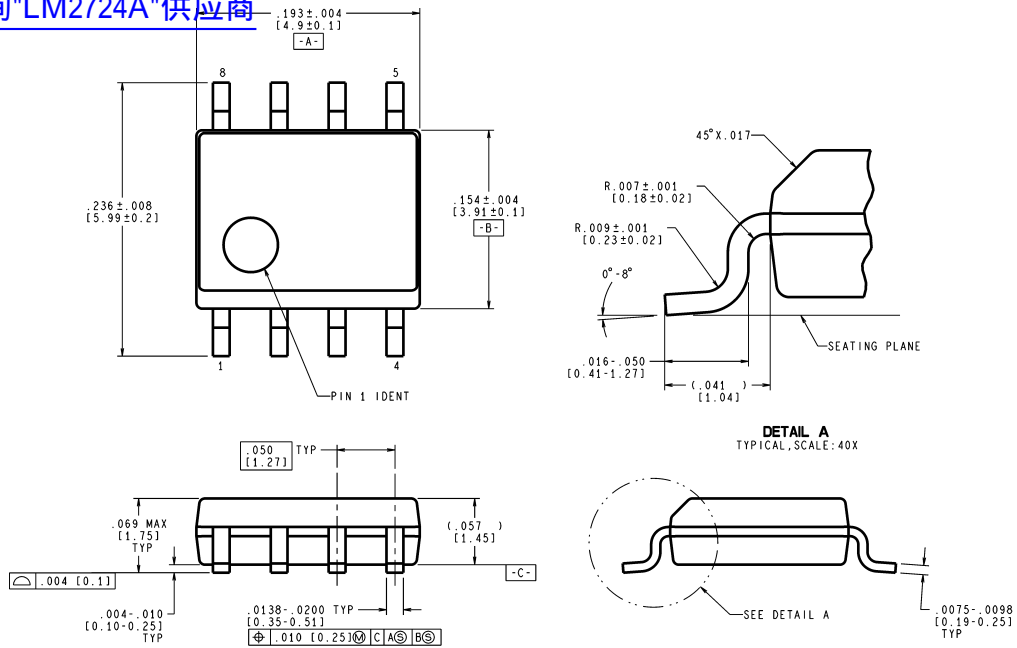
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20073504

Physical Dimensions

inches (millimeters) unless otherwise noted

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CONTROLLING DIMENSION IS INCH
VALUES IN () ARE MILLIMETERS

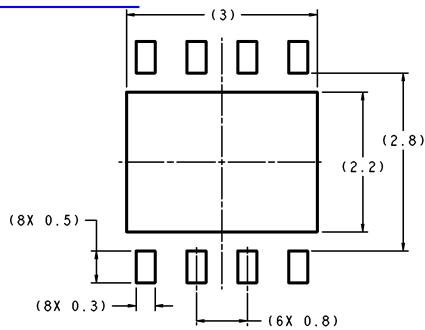
8-Lead Small Outline Package
Order Number LM2724AM, LM2724AMX
NS Package Number M08A

M08A (Rev J)

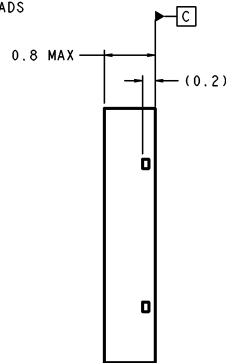
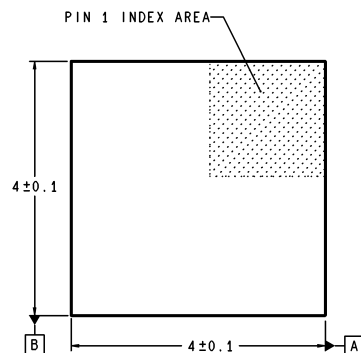
Physical Dimensions

inches (millimeters) unless otherwise noted (Continued)

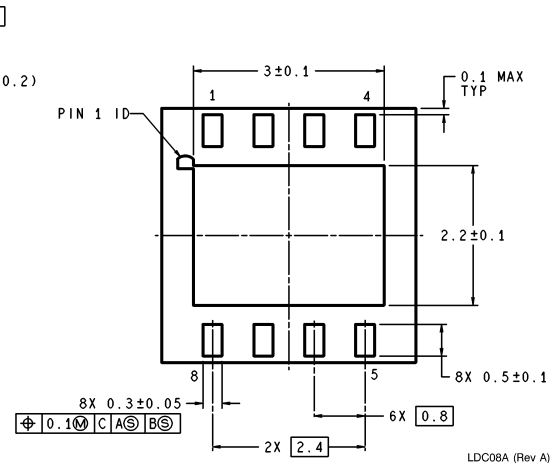
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RECOMMENDED LAND PATTERN
1:1 RATION WITH PKG SOLDER PADS



DIMENSIONS ARE IN MILLIMETERS



LDC08A (Rev A)

8-Lead LLP Package

Order Number LM2724ALD, LM2724ALDX
NS Package Number LDC08A

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